

Lonten N-channel 600V, 2A Power MOSFET

Description

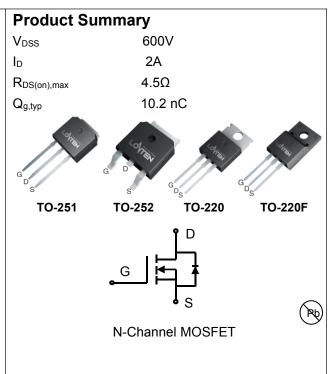
The Power MOSFET is fabricated using the advanced planer VDMOS technology. The resulting device has low conduction resistance, superior switching performance and high avalance energy.

Features

- ♦ Low R_{DS(on)}
- Low gate charge (typ. Q_g = 10.2 nC)
- ◆ 100% UIS tested
- RoHS compliant

Applications

- Power factor correction.
- Switched mode power supplies.
- LED driver.



Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	600	V
Continuous drain current (T _C = 25°C)	ID	2	А
(T _C = 100°C)		1.3	A
Pulsed drain current 1)	I _{DM}	8	A
Gate-Source voltage	V _{GSS}	±30	V
Avalanche energy, single pulse 2)	E _{AS}	80	mJ
Peak diode recovery dv/dt 3)	dv/dt	5	V/ns
Power Dissipation TO-220F (T _C = 25°C)		27	W
Derate above 25°C		0.22	W/°C
Power Dissipation	P _D		
TO-220\ TO-251\ TO-252 (T _C = 25°C)		35	W
Derate above 25°C		0.28	W/°C
Operating juncition and storage temperature range	T _J , T _{STG}	-55 to +150	°C
Continuous diode forward current	Is	2	Α
Diode pulse current	I _{S,pulse}	8	Α

Thermal Characteristics

Dozometer	5		Value	l lmit	
Parameter	Symbol	TO-220F	TO-220\TO-251\TO-252	Unit	
Thermal resistance, Junction-to-case	R _{eJC}	4.63	3.57	°C/W	
Thermal resistance, Junction-to-ambient	R _{0JA}	100	62	°C/W	

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Package Marking and Ordering Information

Device	Device Package	Marking	Units/Tube	Units/Real
LNC2N60	TO-220	LNC2N60	50	
LND2N60	TO-220F	LND2N60	50	
LNG2N60	TO-252	LNG2N60		3000
LNH2N60	TO-251	LNH2N60	72	

Electrical Characteristics T_c = 25°C unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Static characteristics	•					
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0 V, I _D =0.25 mA	600	-	-	V
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =0.25 mA	2	-	4	V
Drain cut-off current	I _{DSS}	V _{DS} =600 V, V _{GS} =0 V,				
		T _j = 25°C	-	-	1	μΑ
		T _j = 125°C	-		100	
Gate leakage current, Forward	I _{GSSF}	V _{GS} =30 V, V _{DS} =0 V	-	-	100	nA
Gate leakage current, Reverse	I _{GSSR}	V _{GS} =-30 V, V _{DS} =0 V	-	-	-100	nA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =10 V, I _D =1 A	-	3.6	4.5	Ω
Dynamic characteristics	•					•
Input capacitance	C _{iss}	V _{DS} = 25 V, V _{GS} = 0 V,	-	338	-	
Output capacitance	Coss	f = 1 MHz	-	36	-	pF
Reverse transfer capacitance	Crss		-	3.4	-]
Turn-on delay time	t _{d(on)}	V _{DD} = 300 V, I _D = 2 A	-	16.8	-	
Rise time	tr	$R_G = 10 \Omega, V_{GS} = 15 V$	-	35.5	-	ns
Turn-off delay time	t _{d(off)}	1	-	34.3	-	1
Fall time	t _f		-	24.7	-	
Gate charge characteristics	-		-			'
Gate to source charge	Q _{gs}	V _{DD} =480 V, I _D =2 A,	-	2.6	-	
Gate to drain charge	Q_{gd}	V _{GS} =0 to 10 V	-	4.7	-	nC
Gate charge total	Qg		-	10.2	-]
Gate plateau voltage	V _{plateau}		-	5	-	V
Reverse diode characteristics	•	•			•	•
Diode forward voltage	V _{SD}	V _{GS} =0 V, I _F =2 A	-	-	1.3	V
Reverse recovery time	t _{rr}	V _R =400 V, I _F =2 A,	-	194	-	ns
Reverse recovery charge	Qrr	dI _F /dt=100 A/µs	-	0.7	-	μC
Peak reverse recovery current	Irrm		-	7.4	-	А

Notes:

- 1. Pulse width limited by maximum junction temperature.
- 2. L=10mH, I_{AS} = 4A, Starting T_j = 25°C.
- 3. I_{SD} = 2A, di/dt \leq 100A/us, $V_{DD}\leq$ B V_{DS} , Starting T_j = 25°C.

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Electrical Characteristics Diagrams

Figure 1. Typical Output Characteristics

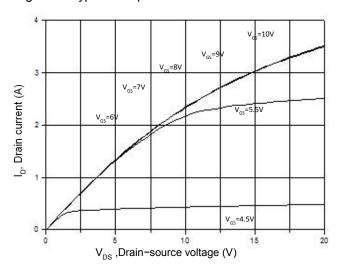


Figure 3. On-Resistance Variation vs. Drain Current

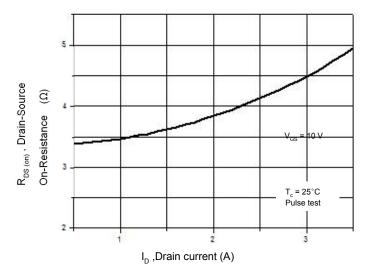


Figure 5. Breakdown Voltage vs. Temperature

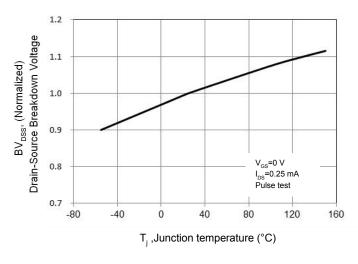


Figure 2. Transfer Characteristics

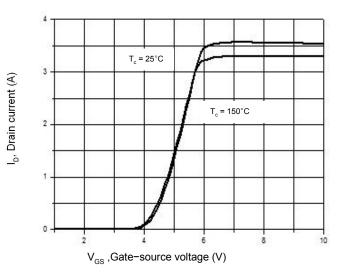


Figure 4. Threshold Voltage vs. Temperature

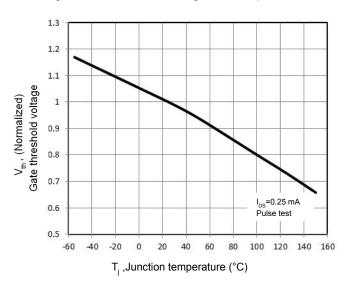


Figure 6. On-Resistance vs. Temperature

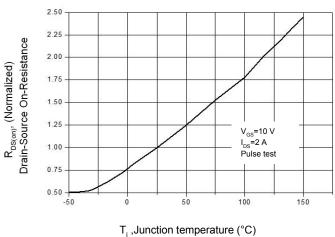




Figure 7. Capacitance Characteristics

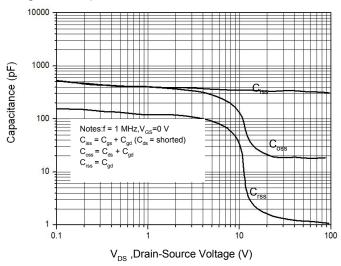


Figure 9. Maximum Safe Operating Area TO-220F

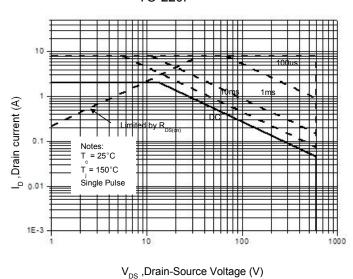


Figure 11. Power Dissipation vs. Temperature TO-220F

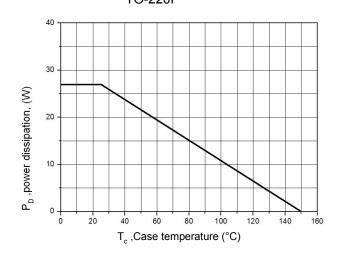
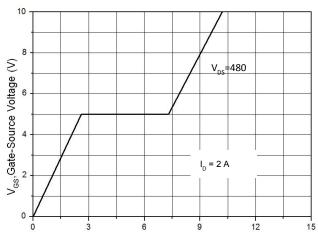


Figure 8. Gate Charge Characterist



Q_G ,Total Gate Charge (nC)

Figure 10. Maximum Safe Operating Area TO-220/ TO-251/TO-252

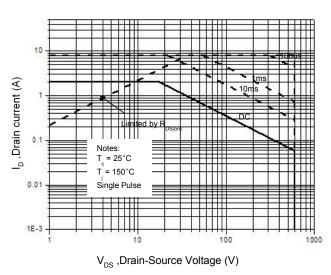
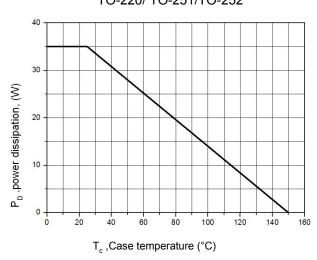


Figure 12. Power Dissipation vs. Temperature TO-220/ TO-251/TO-252



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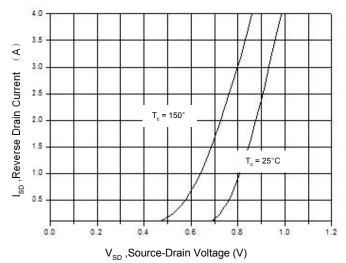
50

0 L

Figure 13. Continuous Drain Current vs. Temperature



Figure 14. Body Diode Transfer Characteristics



T_c ,Case temperature (°C)

75

100

125

Figure 15 Transient Thermal Impendance, Junction to Case, TO-220F

150

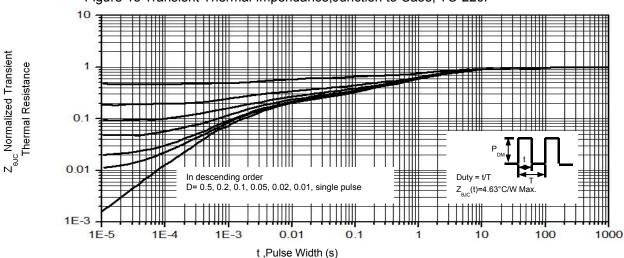
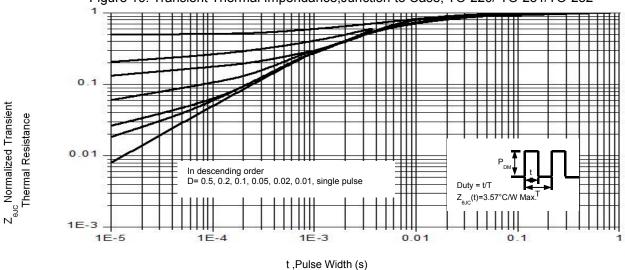


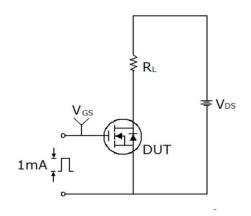
Figure 16. Transient Thermal Impendance, Junction to Case, TO-220/ TO-251/TO-252

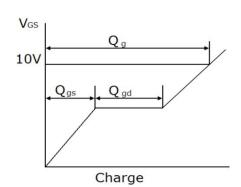


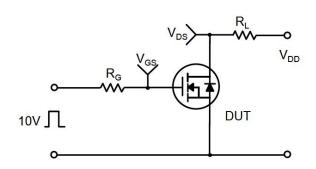
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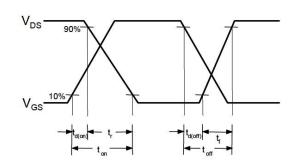


Gate Charge Test Circuit & Waveform

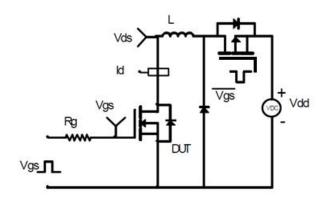


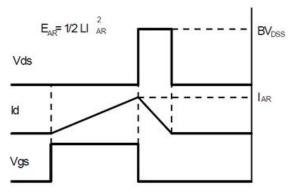






Unclamped Inductive Switching Test Circuit & Waveforms



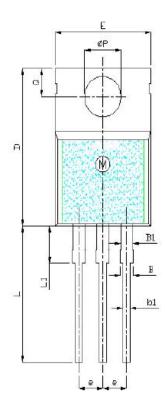


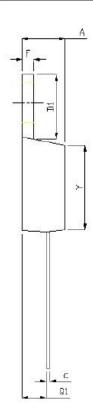
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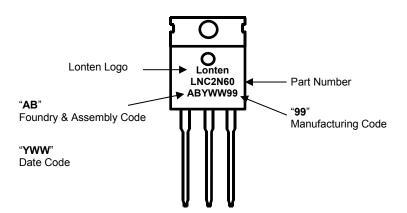
Mechanical Dimensions for TO-220

SYMBOL	N/	567	MAX	SYMBOL	8	UNIT: mm		
	MIN	NOM			MIN	NOM	MAX	
A	4		4. 8	0	2.44	2. 54	2. 64	
В	1.2	0	1.4	F	1.1		1.4	
B1	1	0	1.4	L	12.5		14.5	
b1	0.75	66	0.95	L1	3	3. 5	4	
С	0.4		0.55	ФР	3. 7	3. 8	3. 9	
D	15		16.5	Q	2.5		3	
D1	5.9	20	6. 9	Q1	2	:	2. 9	
Ε	9.9	3	10.7	Υ	8. 02	8. 12	8. 22	





TO-220 Part Marking Information

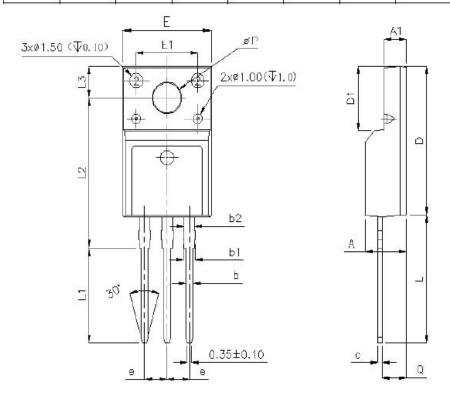


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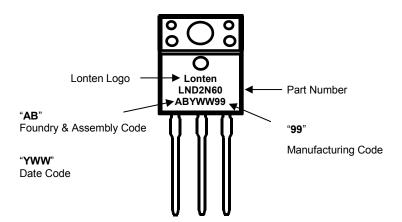


Mechanical Dimensions for TO-220F

SYMBOL	133		MAX	SYMBOL	NO.	UNIT: mm		
	MIN	NOM			MIN	NOM	MAX	
A	4.5		4. 9	E1	6.5	7	7. 5	
A1	2.3		2.9	е	2. 44	2.54	2. 64	
ь	0.65		0.9	L	12.5		14.3	
b1	1.1		1.7	L1	9.45		10.05	
b2	1.2		1.4	L2	15		16	
c	0.35		0. 65	L3	3. 2		4.4	
D	14.5		16.5	ФР	3		3. 3	
D1	6.1		6. 9	Q	2.5	2	2.9	
E	9.6		10. 3					



TO-220F Part Marking Information

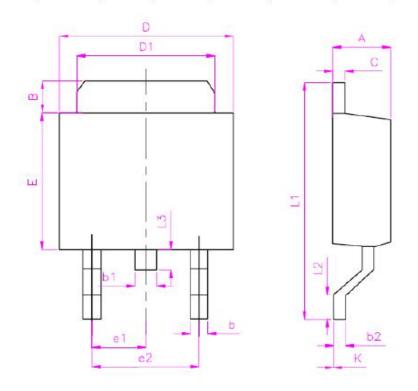


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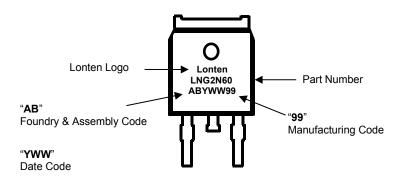


Mechanical Dimensions for TO-252

SYMBOL		IN NOM MA				UNIT: mm		
	MIN		MAX	SYMBOL	MIN	NOM	MAX	
A	2. 10		2.50	E	5. 80		6. 30	
В	0.80		1. 25	e1	2. 25	2.30	2. 35	
b	0.50		0.85	e2	4. 45		4. 75	
b1	0. 50		0.90	L1	9. 50	8.	10. 20	
b2	0. 45	·	0.60	L2	0. 90	81	1.45	
C	0.45	·	0.60	L3	0. 60	81	1.10	
D	6. 35		6.75	К	-0. 1	52	0.10	
D1	5. 10		5. 50	8 8		515	3	
		•	•			•		



TO-252 Part Marking Information

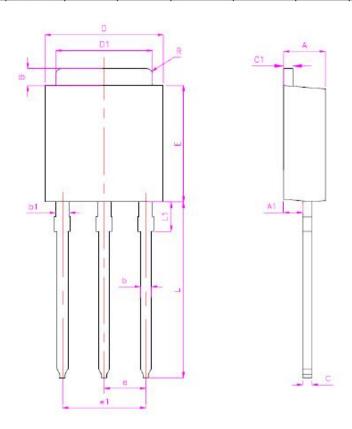


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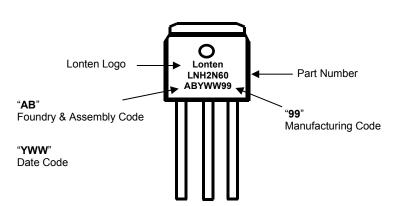


Mechanical Dimensions for TO-251

SYMBOL			MAX			UNIT: mm		
	MIN	NOM		SYMBOL	MIN	NOM	MAX	
A	2. 10		2.50	D1	5. 10		5. 50	
A1	0.95		1.30	E	5. 80		6. 30	
В	0.80		1. 25	е	2. 25	2. 30	2. 35	
ь	0. 50		0.80	L	7. 70		8. 50	
b1	0. 70		0.90	L1	1. 45		1.95	
С	0. 45		0.60	R		0.30		
C1	0.45		0.60					
D	6. 35		6.75					
$\overline{}$		•	-	-		-		



TO-251 Part Marking Information



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